

ABSTRACT

To provide a molding technology for obtaining a molded article from a liquid crystal resin composition to have a superior appearance, in which fibrillation of the surface of the injection-molded article is suppressed even if ultrasonically cleaned. In particular, to provide a molding technology that is implementable even under conditions where the mold temperature is no greater than 100°C. In injection molding of a liquid crystal resin composition, injection molding is performed using a mold having a heat-insulating layer formed on a mold inner surface, and under molding conditions that satisfy a certain relational formula, in which t_1 is thickness of the heat-insulating layer (μm), S is injection molding speed (mm/sec), t_2 is thickness of the injection-molded article (mm), and T is mold temperature ($^{\circ}\text{C}$). Preferably, molding is performed at a mold temperature no greater than 100°C.